



SMD Comm X8G HT150C, Ceramic, 180 pF, 10%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0402, 0.3 mm



General Information	
Series	SMD Comm X8G HT150C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	1.06 mg
Shelf Life	78 Weeks
MSL	1

0402
1mm +/-0.05mm
0.5mm +/-0.05mm
0.5mm +/-0.05mm
0.3mm MIN
0.3mm +/-0.1mm

Т	0.5mm +/-0.05mm
S	0.3mm MIN
В	0.3mm +/-0.1mm
Packaging Specifications	

50000

Packaging

Packaging Quantity

Specifications		
Capacitance	180 pF	
Measurement Condition	1 MHz 1.0Vrms	
Tolerance	10%	
Voltage DC	250 VDC	
Dielectric Withstanding Voltage	625 VDC	
Temperature Range	-55/+150°C	
Temp. Coefficient	X8G	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms	
Dissipation Factor	0.1% 1 MHz 1.0Vrms	
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours	
Insulation Resistance	100 GOhms	

Aging Rate	0% L Time
Insulation Resistance	100

T&R, 330mm, Paper Tape

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